Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	25019	semiconductor and ((connect\$3 or contact\$3) adj pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/25 16:55
L2	11976	1 and (hole or recess\$2)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/25 16:55
L3	9796	2 and (interconnect\$3 or wir\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ÓN	2004/12/25 16:56
L4	7851	3 and (insulat\$3 or dielectric)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/25 16:57
L5	1037	4 and bump and encapsulat\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/12/25 16:57